

## Description

### JMP N-channel MOSFET

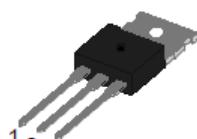
#### Features

- 100V, 33A
- $R_{DS(ON)} \leq 44m\Omega$  @  $V_{GS} = 10V$ ,  $I_D = 16A$
- Fast Switching
- 100% Avalanche Tested
- Improved dv/dt Capability

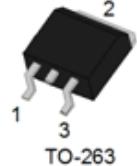
#### Application

- Switch Mode Power Supply (SMPS)
- Uninterruptible Power Supply (UPS)
- Power Factor Correction (PFC)

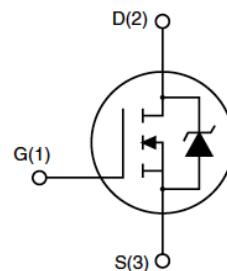
#### Package



JMPC540A



JMPE540A



#### Absolute Maximum Ratings ( $T_c=25^\circ C$ unless otherwise specified)

Symbol	Parameter		Max.	Units
$V_{DSS}$	Drain-Source Voltage		100	V
$V_{GSS}$	Gate-Source Voltage		$\pm 20$	V
$I_D$	Continuous Drain Current	$T_c = 25^\circ C$	33	A
		$T_c = 100^\circ C$	23	A
$I_{DM}$	Pulsed Drain Current <sup>note1</sup>		110	A
$E_{AS}$	Single Pulsed Avalanche Energy <sup>note2</sup>		185	mJ
$P_D$	Power Dissipation	$T_c = 25^\circ C$	130	W
$R_{\theta JC}$	Thermal Resistance, Junction to Case		1.15	$^\circ C/W$
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient		62	$^\circ C/W$
$T_J, T_{STG}$	Operating and Storage Temperature Range		-55 to +175	$^\circ C$

**Electrical Characteristics** ( $T_C=25^\circ\text{C}$  unless otherwise specified)

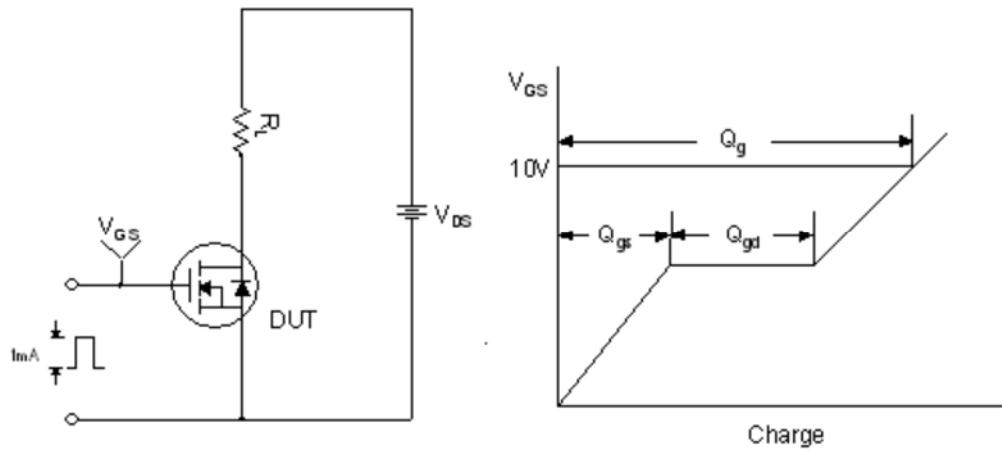
Symbol	Parameter	Test Condition	Min.	Typ.	Max.	Units
<b>Off Characteristic</b>						
$V_{(BR)DSS}$	Drain-Source Breakdown Voltage	$V_{GS} = 0\text{V}, I_D = 250\mu\text{A}$	100	-	-	V
$I_{DSS}$	Zero Gate Voltage Drain Current	$V_{DS} = 100\text{V}, V_{GS} = 0\text{V}$	-	-	25	$\mu\text{A}$
		$V_{DS} = 80\text{V}, V_{GS} = 0\text{V}, T_J = 150^\circ\text{C}$	-	-	250	
$I_{GSS}$	Gate to Body Leakage Current	$V_{GS} = \pm 20\text{V}$	-	-	$\pm 100$	nA
<b>On Characteristics</b>						
$V_{GS(\text{th})}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D = 250\mu\text{A}$	2.0	-	4.0	V
$R_{DS(\text{on})}$	Static Drain-Source On-Resistance note3	$V_{GS} = 10\text{V}, I_D = 16\text{A}$	-	-	44	$\text{m}\Omega$
<b>Dynamic Characteristics</b>						
$C_{iss}$	Input Capacitance	$V_{DS} = 25\text{V}, V_{GS} = 0\text{V}, f = 1.0\text{MHz}$	-	1960	-	pF
$C_{oss}$	Output Capacitance		-	250	-	pF
$C_{rss}$	Reverse Transfer Capacitance		-	40	-	pF
$Q_g$	Total Gate Charge	$V_{DS} = 80\text{V}, I_D = 16\text{A}, V_{GS} = 10\text{V}$	-	-	71	nC
$Q_{gs}$	Gate-Source Charge		-	-	14	nC
$Q_{gd}$	Gate-Drain("Miller") Charge		-	-	21	nC
<b>Switching Characteristics</b>						
$t_{d(on)}$	Turn-On Delay Time	$V_{DD} = 50\text{V}, I_D = 16\text{A}, R_G = 5.1\Omega, V_{GS} = 10\text{V}$	-	11	-	ns
$t_r$	Turn-On Rise Time		-	35	-	ns
$t_{d(off)}$	Turn-Off Delay Time		-	39	-	ns
$t_f$	Turn-Off Fall Time		-	35	-	ns
<b>Drain-Source Diode Characteristics and Maximum Ratings</b>						
$I_S$	Maximum Continuous Drain to Source Diode Forward Current	-	-	33	A	
$I_{SM}$	Maximum Pulsed Drain to Source Diode Forward Current	-	-	110	A	
$V_{SD}$	Drain to Source Diode Forward Voltage	$V_{GS} = 0\text{V}, I_{SD} = 16\text{A}, T_J = 25^\circ\text{C}$	-	-	1.2	V
$t_{rr}$	Reverse Recovery Time	$T_J = 25^\circ\text{C}, I_F = 16\text{A}, \text{di/dt} = 100\text{A}/\mu\text{s}$	-	115	170	ns
$Q_{rr}$	Reverse Recovery Charge		-	505	760	uC

Notes: 1. Repetitive Rating: Pulse width limited by maximum junction temperature

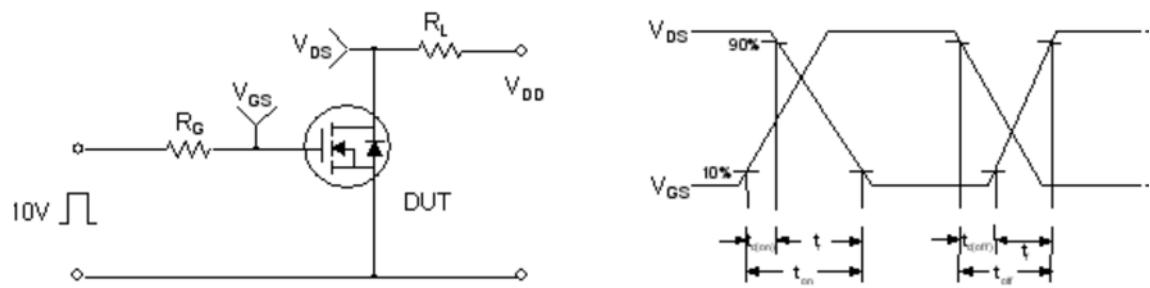
2.  $I_{AS} = 16\text{A}, L = 1.5\text{mH}, R_G = 25\Omega$  Starting  $T_J = 175^\circ\text{C}$

3. Pulse Test: Pulse width  $\leq 400\mu\text{s}$ , Duty Cycle  $\leq 2\%$

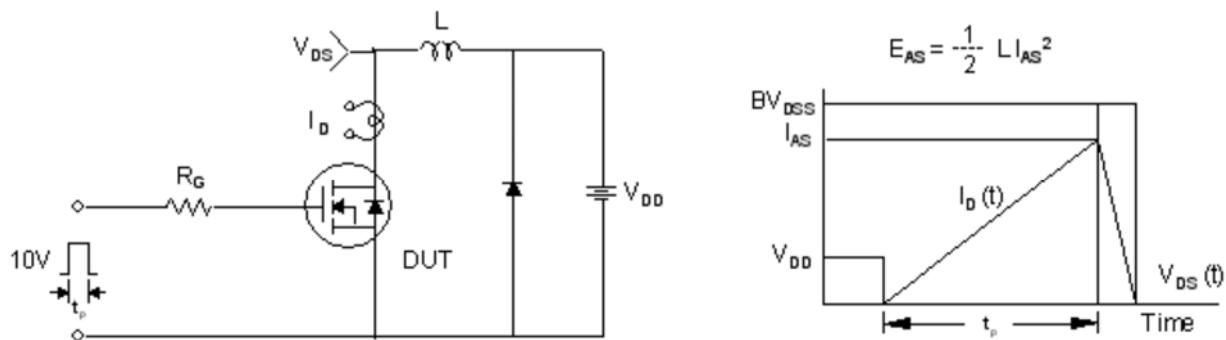
## Typical Performance Characteristics



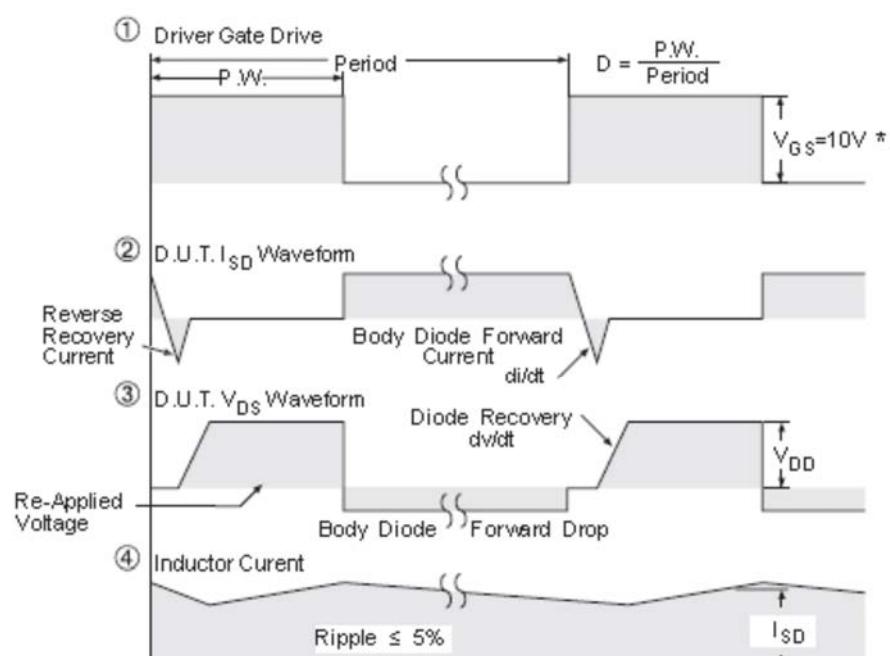
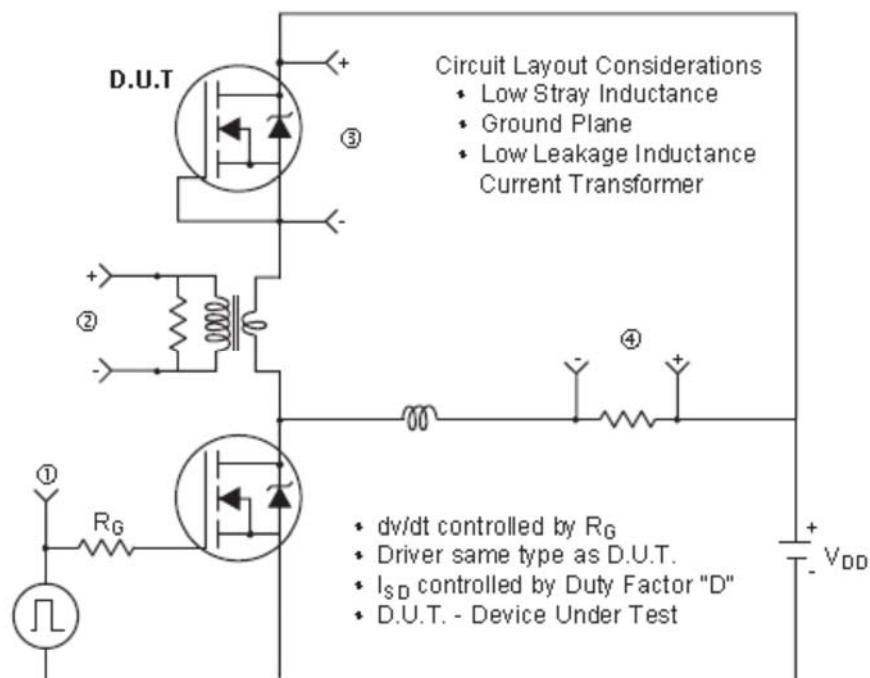
**Figure 1. Gate Charge Test Circuit & Waveform**



**Figure 2. Resistive Switching Test Circuit & Waveforms**



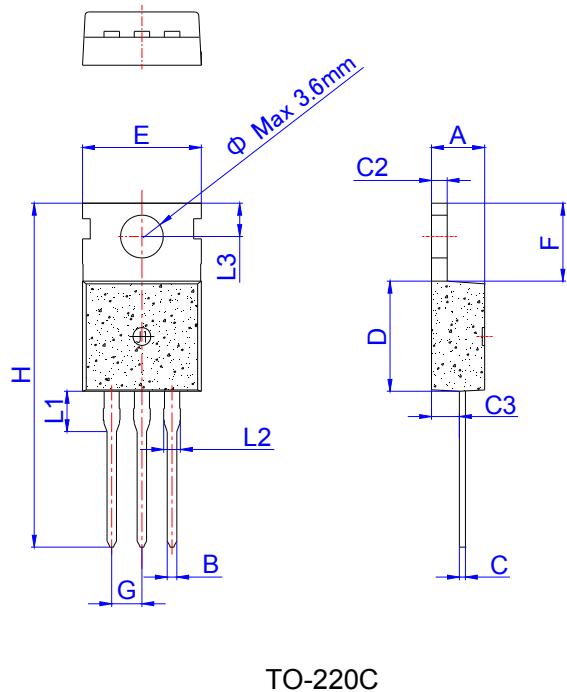
**Figure 3. Unclamped Inductive Switching Test Circuit & Waveforms**



\*  $V_{GS} = 5V$  for Logic Level Devices

Figure 4. Peak Diode Recovery dv/dt Test Circuit & Waveforms (For N-channel)

## Package Mechanical Data

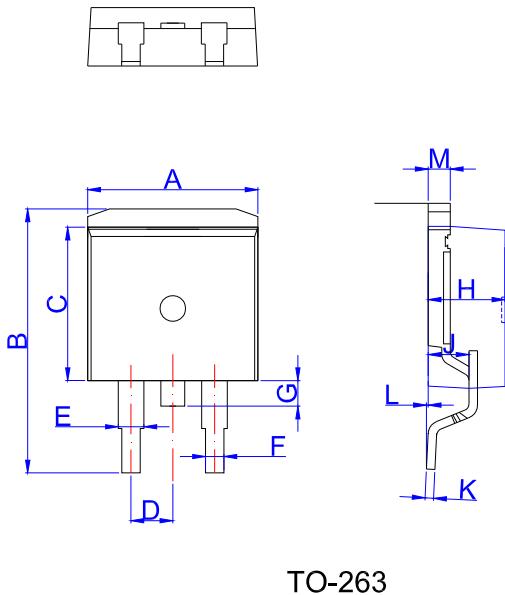


Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	4.40		4.60	0.173		0.181
B	0.70		0.90	0.028		0.035
C	0.45		0.60	0.018		0.024
C2	1.23		1.32	0.048		0.052
C3	2.20		2.60	0.087		0.102
D	8.90		9.90	0.350		0.390
E	9.90		10.3	0.390		0.406
F	6.30		6.90	0.248		0.272
G		2.54			0.1	
H	28.0		29.8	1.102		1.173
L1		3.39			0.133	
L2	1.14		1.70	0.045		0.067
L3	2.65		2.95	0.104		0.116
Φ		3.6			0.142	

## Package Information-TO-220C

OUTLINE	TUBE (PCS)	INNER BOX (PCS)	PER CARTON (PCS)
TUBE	50	1,000	8,000

## Package Mechanical Data



TO-263

Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	9.90		10.20	0.390		0.402
B	14.70		15.80	0.579		0.622
C	9.4		9.6	0.37		0.378
D		2.54			0.100	
E	1.20		1.40	0.047		0.055
F	0.75		0.85	0.029		0.033
G			1.75			0.069
H	4.40		4.70	0.173		0.185
J	2.30		2.70	0.091		0.106
K	0.38		0.55	0.015		0.022
L	0	0.10	0.25	0	0.004	0.010
M	1.25		1.35	0.049		0.053

## Package Information -TO-263

OUTLINE	TUBE (PCS)	INNER BOX (PCS)	PER CARTON (PCS)
TUBE	50	1,000	8,000

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